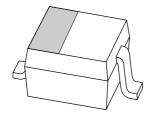
DISCRETE SEMICONDUCTORS

DATA SHEET



BAP63-03 Silicon PIN diode

Product specification Supersedes data of 2001 May 18 2004 Feb 11





Silicon PIN diode BAP63-03

FEATURES

- High speed switching for RF signals
- Low diode capacitance
- Low diode forward resistance
- Very low series inductance
- For applications up to 3 GHz.

APPLICATIONS

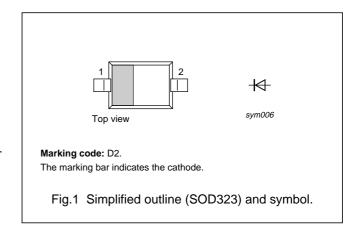
• RF attenuators and switches.

DESCRIPTION

Planar PIN diode in a SOD323 small SMD plastic package.

PINNING

PIN	DESCRIPTION
1	cathode
2	anode



ORDERING INFORMATION

TYPE		PACKAGE				
NUMBER	NAME	DESCRIPTION	VERSION			
BAP63-03	_	plastic surface mounted package; 2 leads	SOD323			

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_R	continuous reverse voltage		_	50	V
I _F	continuous forward current		_	100	mA
P _{tot}	total power dissipation	T _s ≤ 90 °C	_	500	mW
T _{stg}	storage temperature		-65	+150	°C
T _j	junction temperature		-65	+150	°C

Silicon PIN diode BAP63-03

ELECTRICAL CHARACTERISTICS

 $T_i = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V _F	forward voltage	I _F = 50 mA	0.95	1.1	V
I _R	reverse leakage current	V _R = 35 V	_	10	nA
C _d	diode capacitance	V _R = 0; f = 1 MHz	0.4	_	pF
		V _R = 1 V; f = 1 MHz	0.35	_	pF
		V _R = 20 V; f = 1 MHz	0.27	0.32	pF
r _D	diode forward resistance	I _F = 0.5 mA; f = 100 MHz; note 1	2.5	3.5	Ω
		I _F = 1 mA; f = 100 MHz; note 1	1.95	3	Ω
		I _F = 10 mA; f = 100 MHz; note 1	1.17	1.8	Ω
		I _F = 100 mA; f = 100 MHz; note 1	0.9	1.5	Ω
S ₂₁ ²	isolation	V _R = 0; f = 900 MHz	15.4	_	dB
		V _R = 0; f = 1800 MHz	10.1	_	dB
		V _R = 0; f = 2450 MHz	7.8	_	dB
S ₂₁ ²	insertion loss	I _F = 0.5 mA; f = 900 MHz	0.21	_	dB
		I _F = 0.5 mA; f = 1800 MHz	0.28	_	dB
		I _F = 0.5 mA; f = 2450 MHz	0.38	_	dB
S ₂₁ ²	insertion loss	I _F = 1 mA; f = 900 MHz	0.18	_	dB
		I _F = 1 mA; f = 1800 MHz	0.26	_	dB
		I _F = 1 mA; f = 2450 MHz	0.35	_	dB
S ₂₁ ²	insertion loss	I _F = 10 mA; f = 900 MHz	0.13	_	dB
		I _F = 10 mA; f = 1800 MHz	0.20	_	dB
		I _F = 10 mA; f = 2450 MHz	0.30	_	dB
S ₂₁ ²	insertion loss	I _F = 100 mA; f = 900 MHz	0.10	_	dB
		I _F = 100 mA; f = 1800 MHz	0.18	_	dB
		I _F = 100 mA; f = 2450 MHz	0.28	_	dB
τ∟	charge carrier life time	when switched from I_F = 10 mA to I_R = 6 mA; R_L = 100 Ω ; measured at I_R = 3 mA	310	-	ns
L _S	series inductance		1.5	_	nH

Note

1. Guaranteed on AQL basis: inspection level S4, AQL 1.0.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
$R_{th(j-s)}$	thermal resistance from junction to soldering point	120	K/W

Silicon PIN diode BAP63-03

GRAPHICAL DATA

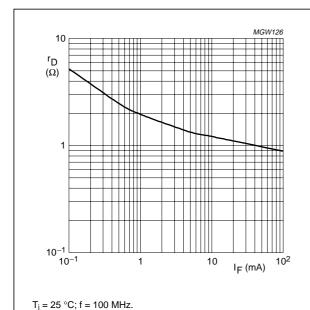


Fig.2 Forward resistance as a function of forward current; typical values.

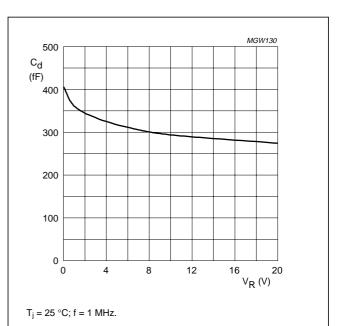


Fig.3 Diode capacitance as a function of reverse voltage; typical values.

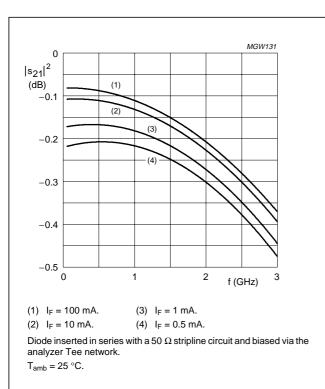
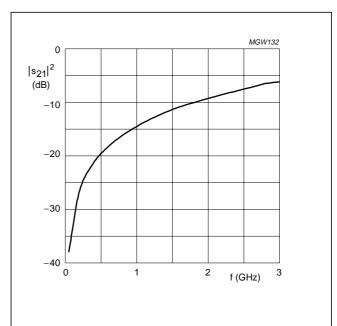


Fig.4 Insertion loss ($|s_{21}|^2$) of the diode in on-state as a function of frequency; typical values.



Diode zero biased and inserted in series with a 50 Ω stripline circuit. $\rm T_{amb}$ = 25 $^{\circ}C.$

Fig.5 Isolation ($|s_{21}|^2$) of the diode in off-state as a function of frequency; typical values.

2004 Feb 11

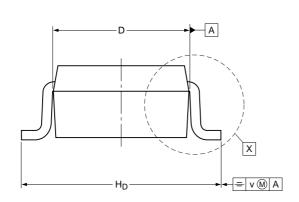
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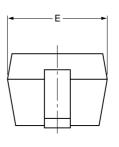
Silicon PIN diode BAP63-03

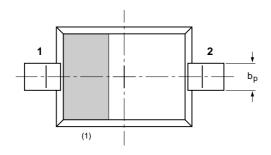
PACKAGE OUTLINE

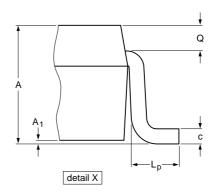
Plastic surface mounted package; 2 leads

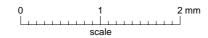
SOD323











DIMENSIONS (mm are the original dimensions)

UNIT	Α	A ₁ max	bp	С	D	E	H _D	Lp	Q	v
mm	1.1 0.8	0.05	0.40 0.25	0.25 0.10	1.8 1.6	1.35 1.15	2.7 2.3	0.45 0.15	0.25 0.15	0.2

Note

1. The marking bar indicates the cathode

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOD323			SC-76			-99-09-13 03-12-17

Silicon PIN diode BAP63-03

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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